

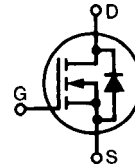
# HiPerFET™ Power MOSFETs Q-Class

IXFH 20N60Q  
IXFT 20N60Q

$V_{DSS} = 600 \text{ V}$   
 $I_{D25} = 20 \text{ A}$   
 $R_{DS(on)} = 0.35 \text{ } \Omega$

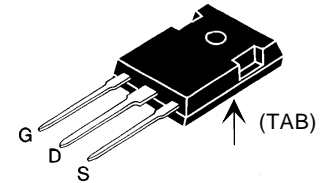
$t_{rr} \leq 250 \text{ ns}$

N-Channel Enhancement Mode  
Avalanche Rated, High  $dv/dt$ ,  
Low Gate Charge and Capacitances

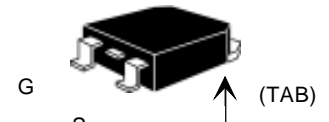


| Symbol    | Test Conditions  | Maximum Ratings |                  |
|-----------|--|-----------------|------------------|
| $V_{DSS}$ | $T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$  | 600             | V                |
| $V_{DGR}$ | $T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$ ; $R_{GS} = 1 \text{ M}\Omega$   | 600             | V                |
| $V_{GS}$  | Continuous   | $\pm 30$        | V                |
| $V_{GSM}$ | Transient  | $\pm 40$        | V                |
| $I_{D25}$ | $T_C = 25^\circ\text{C}$   | 20              | A                |
| $I_{DM}$  | $T_C = 25^\circ\text{C}$ , pulse width limited by $T_{JM}$   | 80              | A                |
| $I_{AR}$  | $T_C = 25^\circ\text{C}$   | 20              | A                |
| $E_{AR}$  | $T_C = 25^\circ\text{C}$   | 30              | mJ               |
| $E_{AS}$  | $T_C = 25^\circ\text{C}$   | 1.5             | J                |
| $dv/dt$   | $I_S \leq I_{DM}$ , $di/dt \leq 100 \text{ A}/\mu\text{s}$ , $V_{DD} \leq V_{DSS}$ ,<br>$T_J \leq 150^\circ\text{C}$ , $R_G = 2 \text{ } \Omega$ | 15              | V/ns             |
| $P_D$     | $T_C = 25^\circ\text{C}$   | 300             | W                |
| $T_J$     |  | -55 ... +150    | $^\circ\text{C}$ |
| $T_{JM}$  |  | 150             | $^\circ\text{C}$ |
| $T_{stg}$ |  | -55 ... +150    | $^\circ\text{C}$ |
| $T_L$     | 1.6 mm (0.062 in.) from case for 10 s  | 300             | $^\circ\text{C}$ |
| $M_d$     | Mounting torque  | 1.13/10         | Nm/lb.in.        |
| Weight    | TO-247 AD  | 6               | g                |
|           | TO-268   | 4               | g                |

TO-247 AD (IXFH)



TO-268 (IXFT) Case Style



G = Gate  
S = Source  
D = Drain  
TAB = Drain

## Features

- IXYS advanced low gate charge process
- International standard packages
- Low gate charge and capacitance
  - easier to drive
  - faster switching
- Low  $R_{DS(on)}$
- Unclamped Inductive Switching (UIS) rated
- Molding epoxies meet UL 94 V-0 flammability classification

## Advantages

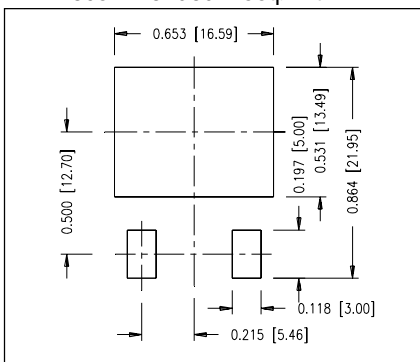
- Easy to mount
- Space savings
- High power density

| Symbol       | Test Conditions<br>( $T_J = 25^\circ\text{C}$ , unless otherwise specified)   | Characteristic Values |      |                      |
|--------------|---|-----------------------|------|----------------------|
|              |   | Min.                  | Typ. | Max.                 |
| $V_{DSS}$    | $V_{GS} = 0 \text{ V}$ , $I_D = 250 \text{ } \mu\text{A}$   | 600                   |      | V                    |
| $V_{GS(th)}$ | $V_{DS} = V_{GS}$ , $I_D = 4 \text{ mA}$  | 2.0                   |      | V                    |
| $I_{GSS}$    | $V_{GS} = \pm 30 \text{ V}_{DC}$ , $V_{DS} = 0$   |                       |      | $\pm 100 \text{ nA}$ |
| $I_{DSS}$    | $V_{DS} = V_{DSS}$ , $T_J = 25^\circ\text{C}$   |                       |      | 25 $\mu\text{A}$     |
|              | $V_{GS} = 0 \text{ V}$ , $T_J = 125^\circ\text{C}$  |                       |      | 1 mA                 |
| $R_{DS(on)}$ | $V_{GS} = 10 \text{ V}$ , $I_D = 0.5 I_{D25}$<br>Pulse test, $t \leq 300 \text{ } \mu\text{s}$ , duty cycle $d \leq 2 \%$ |                       |      | 0.35 $\Omega$        |

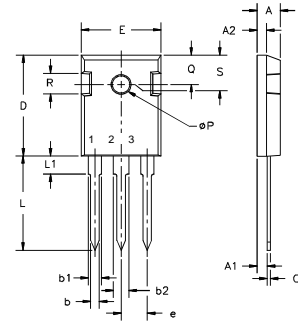
| Symbol       | Test Conditions   | Characteristic Values<br>( $T_J = 25^\circ\text{C}$ , unless otherwise specified) |      |      |
|--------------|---|---|------|------|
|              |   | Min.  | Typ. | Max. |
| $g_{fs}$     | $V_{DS} = 10\text{ V}; I_D = 0.5 I_{D25}$ , pulse test  | 10  | 20   | S    |
| $C_{iss}$    | $V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$                                     |   | 3300 | pF   |
| $C_{oss}$    |   |   | 410  | pF   |
| $C_{rss}$    |   |   | 130  | pF   |
| $t_{d(on)}$  | $V_{GS} = 10\text{ V}, V_{DS} = 0.5 V_{DSS}, I_D = 0.5 I_{D25}$<br>$R_G = 1.5\ \Omega$ (External) |   | 20   | ns   |
| $t_r$        |   |   | 20   | ns   |
| $t_{d(off)}$ |   |   | 45   | ns   |
| $t_f$        |   |   | 20   | ns   |
| $Q_{g(on)}$  | $V_{GS} = 10\text{ V}, V_{DS} = 0.5 V_{DSS}, I_D = 0.5 I_{D25}$                                   |   | 90   | nC   |
| $Q_{gs}$     |   |   | 20   | nC   |
| $Q_{gd}$     |   |   | 45   | nC   |
| $R_{thJC}$   | (TO-247)  |   | 0.42 | KW   |
| $R_{thCK}$   |   |   | 0.25 | KW   |

| Symbol   | Test Conditions   | Characteristic Values<br>( $T_J = 25^\circ\text{C}$ , unless otherwise specified) |      |               |
|----------|---|---|------|---------------|
|          |   | min.  | typ. | max.          |
| $I_S$    | $V_{GS} = 0\text{ V}$   |   |      | 20 A          |
| $I_{SM}$ | Repetitive; pulse width limited by $T_{JM}$   |   |      | 80 A          |
| $V_{SD}$ | $I_F = I_S, V_{GS} = 0\text{ V}$ ,<br>Pulse test, $t \leq 300\ \mu\text{s}$ , duty cycle $d \leq 2\%$ |   |      | 1.5 V         |
| $t_{rr}$ | $I_F = I_S, -di/dt = 100\text{ A}/\mu\text{s}, V_R = 100\text{ V}$                                    |   | 0.85 | 250 ns        |
| $Q_{RM}$ |   |   |      | $\mu\text{C}$ |
| $I_{RM}$ |   |   |      | 8 A           |

### Min Recommended Footprint



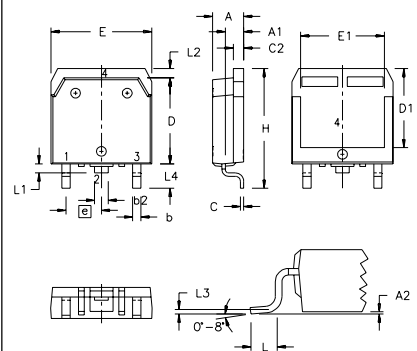
### TO-247 AD Outline



Terminals: 1 - Gate 2 - Drain  
3 - Source Tab - Drain

| Dim.           | Millimeter |       | Inches |       |
|----------------|------------|-------|--------|-------|
|                | Min.       | Max.  | Min.   | Max.  |
| A              | 4.7        | 5.3   | .185   | .209  |
| A <sub>1</sub> | 2.2        | 2.54  | .087   | .102  |
| A <sub>2</sub> | 2.2        | 2.6   | .059   | .098  |
| b              | 1.0        | 1.4   | .040   | .055  |
| b <sub>1</sub> | 1.65       | 2.13  | .065   | .084  |
| b <sub>2</sub> | 2.87       | 3.12  | .113   | .123  |
| C              | .4         | .8    | .016   | .031  |
| D              | 20.80      | 21.46 | .819   | .845  |
| E              | 15.75      | 16.26 | .610   | .640  |
| e              | 5.20       | 5.72  | 0.205  | 0.225 |
| L              | 19.81      | 20.32 | .780   | .800  |
| L <sub>1</sub> |            | 4.50  |        | .177  |
| ØP             | 3.55       | 3.65  | .140   | .144  |
| Q              | 5.89       | 6.40  | 0.232  | 0.252 |
| R              | 4.32       | 5.49  | .170   | .216  |
| S              | 6.15       | BSC   | 242    | BSC   |

### TO-268 Outline



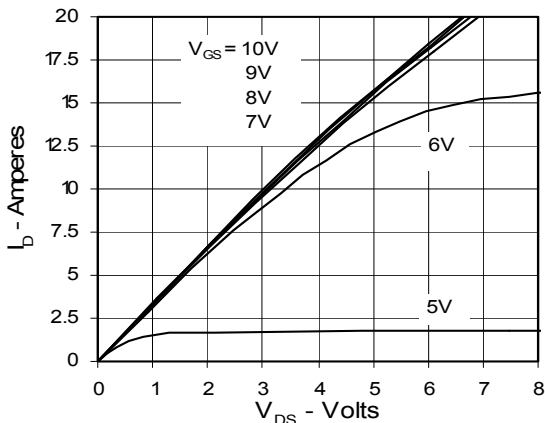
| SYM            | INCHES   |      | MILLIMETERS |       |
|----------------|----------|------|-------------|-------|
|                | MIN      | MAX  | MIN         | MAX   |
| A              | .193     | .201 | 4.90        | 5.10  |
| A <sub>1</sub> | .106     | .114 | 2.70        | 2.90  |
| A <sub>2</sub> | .001     | .010 | 0.02        | 0.25  |
| b              | .045     | .057 | 1.15        | 1.45  |
| b <sub>2</sub> | .075     | .083 | 1.90        | 2.10  |
| C              | .016     | .026 | 0.40        | 0.65  |
| C <sub>2</sub> | .057     | .063 | 1.45        | 1.60  |
| D              | .543     | .551 | 13.80       | 14.00 |
| D <sub>1</sub> | .488     | .500 | 12.40       | 12.70 |
| E              | .624     | .632 | 15.85       | 16.05 |
| E <sub>1</sub> | .524     | .535 | 13.30       | 13.60 |
| e              | .215 BSC |      | 5.45 BSC    |       |
| H              | .736     | .752 | 18.70       | 19.10 |
| L              | .094     | .106 | 2.40        | 2.70  |
| L <sub>1</sub> | .047     | .055 | 1.20        | 1.40  |
| L <sub>2</sub> | .039     | .045 | 1.00        | 1.15  |
| L <sub>3</sub> | .010 BSC |      | 0.25 BSC    |       |
| L <sub>4</sub> | .150     | .161 | 3.80        | 4.10  |

IXYS reserves the right to change limits, test conditions, and dimensions.

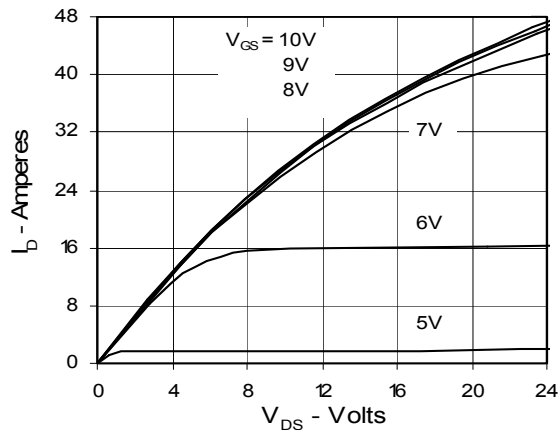
IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents:

4,835,592 4,881,106 5,017,508 5,049,961 5,187,117 5,486,715 6,306,728B1 6,259,123B1 6,306,728B1  
4,850,072 4,931,844 5,034,796 5,063,307 5,237,481 5,381,025 6,404,065B1 6,162,665 6,534,343

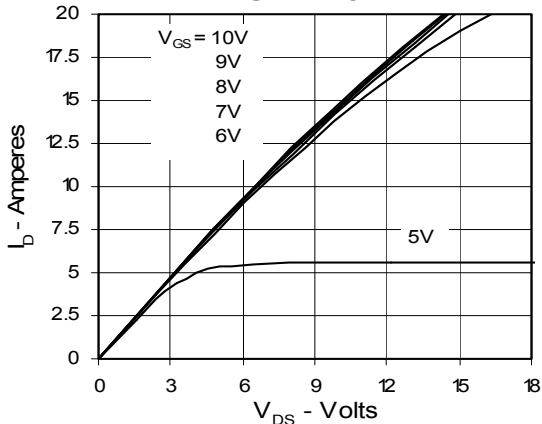
**Fig. 1. Output Characteristics**  
@ 25 Deg. C



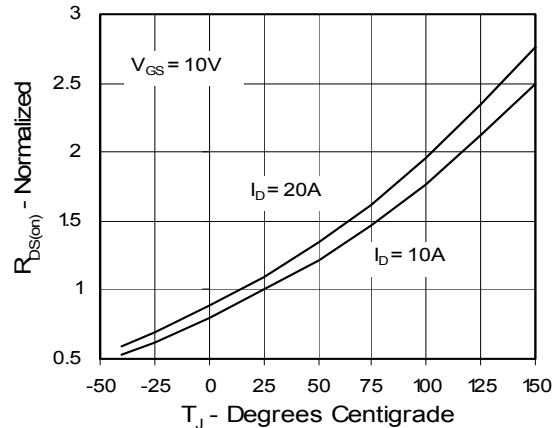
**Fig. 2. Extended Output Characteristics**  
@ 25 deg. C



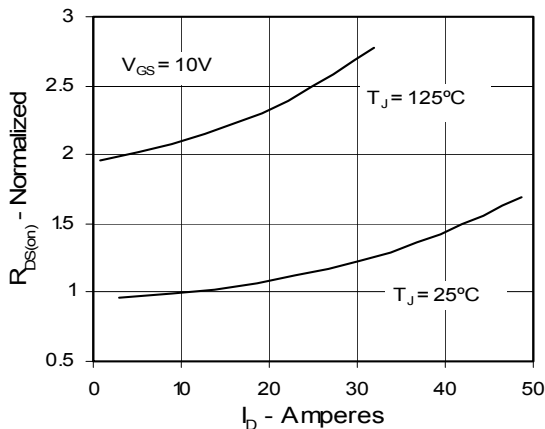
**Fig. 3. Output Characteristics**  
@ 125 Deg. C



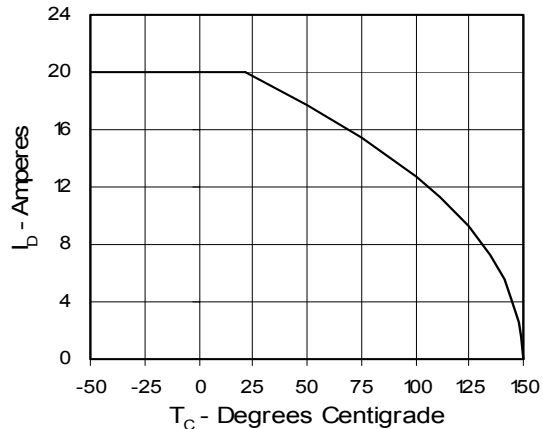
**Fig. 4.  $R_{DS(on)}$  Normalized to  $I_{D25}$  Value vs. Junction Temperature**



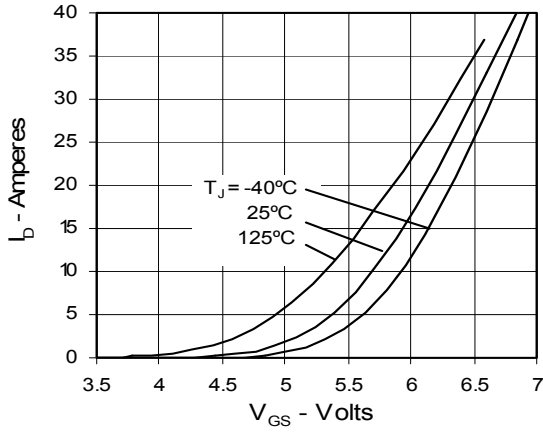
**Fig. 5.  $R_{DS(on)}$  Normalized to  $I_{D25}$  Value vs.  $I_D$**



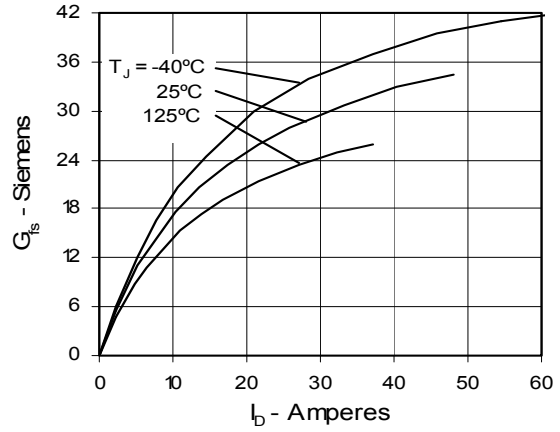
**Fig. 6. Drain Current vs. Case Temperature**



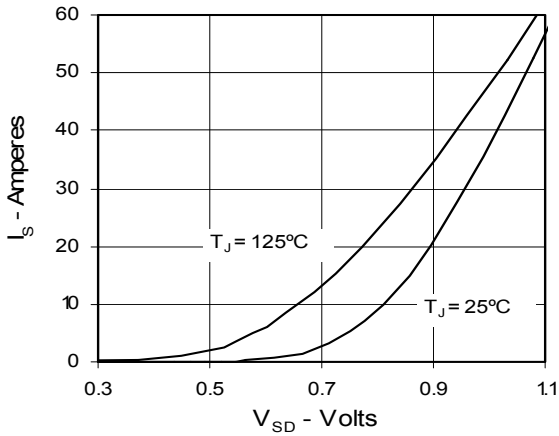
**Fig. 7. Input Admittance**



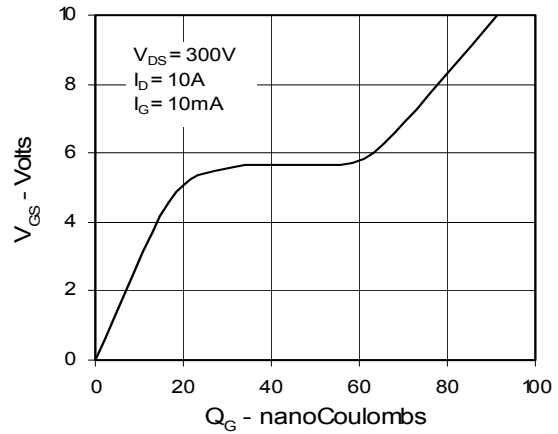
**Fig. 8. Transconductance**



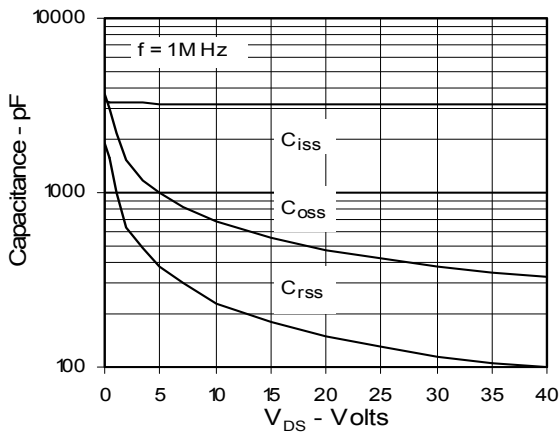
**Fig. 9. Source Current vs. Source-To-Drain Voltage**



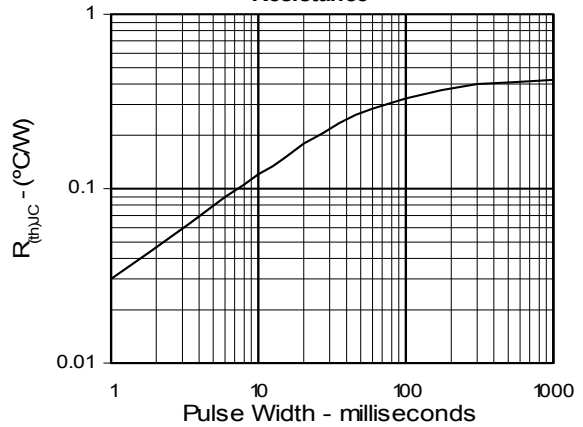
**Fig. 10. Gate Charge**



**Fig. 11. Capacitance**



**Fig. 12. Maximum Transient Thermal Resistance**



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